- Very Low Power Consumption . . . 2 mW Typ at $V_{DD} = 5 \text{ V}$
- Capable of Operation in Astable Mode
- **CMOS Output Capable of Swinging Rail to**
- **High Output-Current Capability** Sink 100 mA Typ Source 10 mA Typ
- Output Fully Compatible With CMOS, TTL, and MOS
- **Low Supply Current Reduces Spikes During Output Transitions**
- High-Impedance Inputs . . . $10^{12} \Omega$ Typ
- Single-Supply Operation From 1 V to 18 V
- Functionally Interchangeable With the NE556; Has Same Pinout

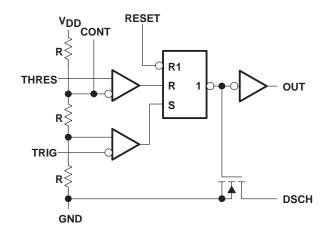
description

The TLC552 is a dual monolithic timing circuit fabricated using TI LinCMOS™ process, which provides full compatibility with CMOS, TTL, and MOS logic and operation at frequencies up to 2 MHz. Accurate time delays and oscillations are possible with smaller, less-expensive timing capacitors than the NE555 because of the high input impedance. Power consumption is low across the full range of power supply voltages.

Like the NE556, the TLC552 has a trigger level approximately one-third of the supply voltage and a threshold level approximately two-thirds of the supply voltage. These levels can be altered by use of the control voltage terminal. When the trigger input falls below the trigger level, the flip-flop is set and the output goes high. If the trigger input is above the trigger level and the threshold input is above the threshold level, the flip-flop is reset and

D OR N PACKAGE (TOP VIEW) DSCH I Λ^{DD} THRES | 13 DSCH CONT [12 THRES **TIMER** 3 RESET [11 CONT **TIMER** 10 ∏ RESET #2 OUT [TRIG [6 9∏OUT GND [8 TRIG

functional block diagram (each timer)



RESET can override TRIG and THRES. TRIG can override THRES.

AVAILABLE OPTIONS

SYMBO	LIZATION	OPERATING	
DEVICE	PACKAGE SUFFIX	TEMPERATURE RANGE	V _T max at 25°C
TLC552C	D,N	0°C to 70°C	3.8 mV

The D packages are available taped and reeled. Add the suffix R to the device type when ordering (i.e., TLC552CDR).

the output is low. The reset input can override all other inputs and can be used to initiate a new timing cycle. If the reset input is low, the flip-flop is reset and the output is low. Whenever the output is low, a low-impedance path is provided between the discharge terminal and ground.

While the CMOS output is capable of sinking over 100 mA and sourcing over 10 mA, the TLC552 exhibits greatly reduced supply-current spikes during output transitions. This minimizes the need for the large decoupling capacitors required by the NE556.

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SLFS046 - FEBRUARY 1984 - REVISED MAY 1988

description (continued)

These devices have internal electrostatic discharge (ESD) protection circuits that will prevent catastrophic failures at voltages up to 2000 V as tested under MIL-STD-883C, Method 3105.2. However, care should be exercised in handling these devices as exposure to ESD may result in a degradation of the device parametric performance.

All unused inputs should be tied to an appropriate logic level to prevent false triggering.

The TLC552C is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

RESET VOLTAGET	TRIGGER VOLTAGE†	THRESHOLD VOLTAGET	ОИТРИТ	DISCHARGE SWITCH	
< MIN	Irrelevant	Irrelevant	Low	On	
> MAX	< MIN	Irrelevant	High	Off	
> MAX	> MAX	> MAX	Low	On	
> MAX	> MAX	< MIN	As previously established		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under electrical characteristics.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{DD} (see Note 1)	18 V
Input voltage range (any input)	– 0.3 V to V _{DD}
Sink current, DSCH or OUT	150 mA
Source current, OUT	15 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range	0°C to 75°C
Storage temperature range	– 65°C to 150°C

NOTES: 1. All voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	AGE POWER RATING DERATING FACTOR		ABOVE T _A
D	950 mW	7.6 mW/°C	25°C
N	1150 mW	9.2 mW/°C	25°C

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, V _{DD}	1	18	V
Operating free-air temperature range, TA	0	70	°C



TLC552C

electrical characteristics at specified free-air temperature, $V_{DD} = 1 V$

PARAMETER	TEST CONDITIONS	T _A †	MIN	TYP	MAX	UNIT	
Threshold voltage level		25°C	0.475	0.67	0.85	V	
Trileshold voltage level		Full range	0.45		0.875	V	
Threshold current		25°C		10		nΛ	
Threshold current		MAX		75		pА	
Trigger voltage level		25°C	0.15	0.33	0.425	V	
Trigger voltage level		Full range	0.1		1.45	V	
Trigger current		25°C		10		pА	
Thigger current		MAX		75		PΛ	
Reset voltage level		25°C	0.4	0.7	1	V	
Neset voltage level		Full range	0.3		1	V	
Reset current		25°C		10		pА	
Reset current		MAX		75			
Control voltage (open-circuit) as a percentage of supply voltage		MAX		66.7%			
Discharge switch on-state voltage	lo 100 A	25°C		0.02	0.15	V	
Discharge Switch on-State voltage	I _{OL} = 100 μA	Full range			0.2]	
Discharge switch off-state current		25°C		0.1		nA	
Discharge Switch on-State current		MAX		0.5		IIA	
Low-level output voltage	Jay - 100 u A	25°C		0.03	0.2	V	
Low-level output voltage	Ι _Ο L = 100 μΑ	Full range			0.25	1 °	
High lovel output voltage	Jan - 10 uA	25°C	0.6	0.98		V	
High-level output voltage	$I_{OH} = -10 \mu\text{A}$	Full range	0.6			V	
Supply ourrent		25°C		30	200		
Supply current		Full range			300	μΑ	

[†]Full range (MIN to MAX) is 0°C to 70°C.

SLFS046 – FEBRUARY 1984 – REVISED MAY 1988

electrical characteristics at specified free-air temperature, V_{DD} = 2 V

PARAMETER	TEST CONDITIONS	T _A †	MIN	TYP	MAX	UNIT	
Threshold voltage level		25°C	0.95	1.33	1.65	V	
Trireshold voltage level		Full range	0.85		1.75	V	
Threshold current		25°C		10		pА	
Threshold current		MAX		75		PΑ	
Trigger voltage level		25°C	0.4	0.67	0.95	V	
Trigger voltage level		Full range	0.3		1.05	V	
Trigger current		25°C		10		pА	
Trigger current		MAX		75		PΛ	
Reset voltage level		25°C	0.4	1.1	1.5	V	
Reset voltage level		Full range	0.3		1.8	V	
Reset current		25°C		10			
Reset current				75		pА	
Control voltage (open-circuit) as a percentage of supply voltage		MAX		66.7%			
Discharge switch on-state voltage	lo 1 mΛ	25°C		0.03	0.2	V	
Discharge switch on-state voltage	I _{OL} = 1 mA	Full range			0.25	V	
Discharge switch off-state current		25°C		0.1		nA	
Discharge switch on-state current		MAX		0.5		IIA	
Low-level output voltage	lo. – 1 mA	25°C		0.07	0.3	V	
Low-level output voltage	I _{OL} = 1 mA	Full range			0.35	V	
Lligh lovel output voltoge	Jan. 200 HA	25°C	1.5	1.9		V	
High-level output voltage	I _{OH} = -300 μA	Full range	1.5			V	
Supply current		25°C		130	500		
Supply current		Full range			800	μΑ	

[†] Full range (MIN to MAX) is 0°C to 70°C.

electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

PARAMETER	TEST CONDITIONS	T _A †	MIN	TYP	MAX	UNIT
Threshold voltage level		25°C	2.8	3.3	3.8	V
Threshold voltage level		Full range	2.7		3.9	V
Threshold current		25°C		10		pА
Threshold current		MAX		75		PΑ
Trigger voltage level		25°C	1.36	1.66	1.96	V
rrigger voltage level		Full range	1.26		2.06	V
Trigger current		25°C		10		pА
ringger current		MAX		75		PΛ
Reset voltage level		25°C	0.4	1.1	1.5	V
Neset voltage level		Full range	0.3		1.8	V
Reset current		25°C		10		pА
Neset current		MAX		75		PΑ
Control voltage (open-circuit) as a percentage of supply voltage		MAX		66.7%		
Discharge switch on-state voltage	I _{OL} = 10 mA	25°C		0.14	0.5	V
Discharge Switch on-State voltage	IOL = 10 IIIA	Full range			0.6	V
Discharge switch off-state current		25°C		0.1		nA
Discharge Switch on-State current		MAX		0.5		ПА
	I _{OL} = 8 mA	25°C		0.21	0.4	
	IOL = 0 IIIA	Full range			0.5	
Low-level output voltage	I _{OL} = 5 mA	25°C		0.13	0.3	V
Low-level output voltage	IOL = 5 IIIA	Full range			0.4	V
	I _{OL} = 3.2 mA	25°C		0.08	0.3	
	10L = 3.2 IIIA	Full range			0.35	
High-level output voltage	I _{OH} = -1 mA	25°C	4.1	4.8		V
i iigii-ievei output voitage	IOH = - I IIIA	Full range	4.1			V
Supply current		25°C		340	700	
очрру синени		Full range			1000	μΑ

[†] Full range (MIN to MAX) is 0°C to 70°C.

SLFS046 – FEBRUARY 1984 – REVISED MAY 1988

electrical characteristics at specified free-air temperature, V_{DD} = 15 V

PARAMETER	TEST CONDITIONS	T _A †	MIN	TYP	MAX	UNIT	
Threshold voltage level		25°C	9.45	10	10.55	V	
Trirestiola voltage level		Full range	9.35		10.65	V	
Threshold current		25°C		10		pА	
Theshold current		MAX		75		PΑ	
Trigger voltage level		25°C	4.65	5	5.35	V	
Trigger voltage level		Full range	4.55		5.45	V	
Trigger current		25°C		10		pА	
Thigger current		MAX		75		PΛ	
Reset voltage level		25°C	0.4	1.1	1.5	V	
Reset voltage level		Full range	0.3		1.8	V	
Reset current		25°C		10		pА	
Reset current		MAX		75		PΑ	
Control voltage (open-circuit) as a percentage of supply voltage		MAX		66.7%			
Discharge quitab en etete valtage	I _{OL} = 100 mA	25°C		0.77	1.7	V	
Discharge switch on-state voltage	IOL = 100 IIIA	Full range			1.8	V	
Discharge quitab off state gurrent		25°C		0.1		nA	
Discharge switch off-state current		MAX		0.5			
	I _{OL} = 100 mA	25°C		1.28	3.2		
	IOC = 100 IIIA	Full range			3.6		
Low-level output voltage	lo 50 m/	25°C		0.63	1	V	
Low-level output voltage	I _{OL} = 50 mA	Full range			1.3	V	
	la. 10 m A	25°C		0.12	0.3		
	I _{OL} = 10 mA	Full range			0.4		
	l 40 σσ.Λ	25°C	12.5	14.2			
	$I_{OH} = -10 \text{ mA}$	Full range	12.5				
High lovel output voltage	la 5 m A	25°C	13.5	14.6		.,,	
High-level output voltage	IOH = -5 mA	Full range	13.5			V	
	lou - 1 m^	25°C	14.2	14.9			
	I _{OH} = -1 mA	Full range	14.2				
Supply ourrent		25°C		0.72	1.2	mΛ	
Supply current		Full range			1.6	mA	

[†] Full range (MIN to MAX) is 0°C to 70°C.

TLC552C

electrical characteristics at specified free-air temperature, V_{DD} = 18 V

PARAMETER	TEST CONDITIONS	T _A †	MIN	TYP	MAX	UNIT
Threshold voltage level		25°C	11.4	12	12.6	V
Trileshold voltage level		Full range	10.9		12.7	V
Threshold current		25°C		10		pА
Threshold current		MAX		75		PΑ
Trigger voltage level		25°C	5.6	6	6.4	V
Trigger voltage level		Full range	5.5		6.5	V
Trigger current		25°C		10		pА
Trigger current		MAX		75		PΑ
Reset voltage level		25°C	0.4	1.1	1.5	V
Reset voltage level		Full range	0.3		1.8	V
Reset current		25°C		10		n 1
Reset current		MAX		75		pА
Control voltage (open-circuit) as a percentage of supply voltage		MAX		66.7%		
Discharge switch on-state voltage	IOI = 100 mA	25°C		0.72	1.5	V
Discharge Switch off-state voltage	IOT = 100 IIIY	Full range			1.6	V
Discharge switch off-state current		25°C		0.1		nA
Discharge Switch oil-state current		MAX		0.5		TIA
Low-level output voltage	IOI = 3.2 mA	25°C		0.04	0.3	V
Low-level output voltage	IOL = 3.2 IIIA	Full range			0.35	V
High-level output voltage	Jan - 1 m/	25°C	17.3	17.9		V
Triginievel output voltage	I _{OH} = -1 mA	Full range	17.3			V
Supply current		25°C		0.84	1.2	mA
Supply current		Full range			1.6	IIIA

[†] Full range (MIN to MAX) is 0°C to 70°C.

operating characteristics, V_{DD} = 5 V, T_A = 25°C (unless otherwise noted)

PARAMETER	TEST CONDITIONS			TYP	MAX	UNIT
Initial error of timing interval‡	$V_{DD} = 5 \text{ V to } 15 \text{ V},$	$R_A = R_B = 1 \text{ k}\Omega \text{ to } 100 \text{ k}\Omega,$		1%	3%	
Supply voltage sensitivity of timing interval	$C_T = 0.1 \mu\text{F},$ See Note 2			0.1	0.5	%/V
Output pulse rise time	D. 40 MO	C: 10 pF		20	75	
Output pulse fall time	$R_L = 10 M\Omega$,	C _L = 10 pF		15	60	ns
Maximum frequency in astable mode	$R_A = 470 \Omega$, $C_T = 200 pF$,	$R_B = 200 \Omega$, See Note 2	1.2	2.8		MHz

[‡] Timing interval error is defined as the difference between the measured value and the nominal value of a random sample. NOTE 2: R_A, R_B, and C_T are as defined in Figure 1.



APPLICATION INFORMATION

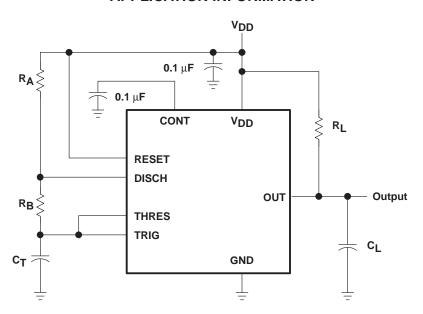


Figure 1. Circuit for Astable Operation





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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
TLC552CD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TLC552CDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TLC552CDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TLC552CDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TLC552CN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
TLC552CNE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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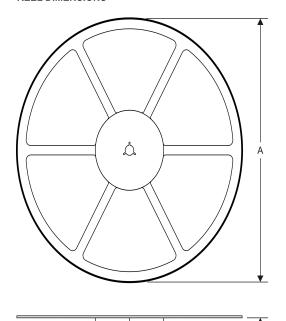
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



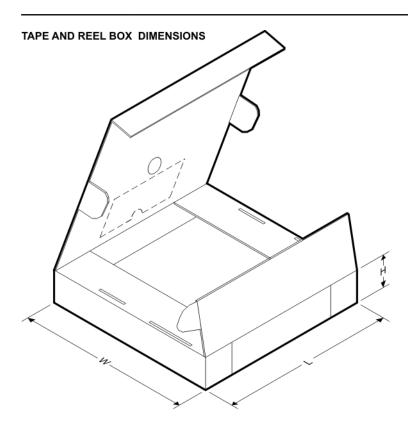
A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	•	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC552C	DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

www.ti.com 14-Jul-2012



*All dimensions are nominal

Ī	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	TLC552CDR	SOIC	D	14	2500	367.0	367.0	38.0

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